#### **TOSHIBA** Photocoupler Photorelay

# TLP797GA

#### **Cordless Telephone** PBX MODEM

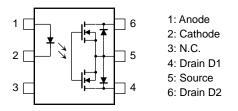
The TOSHIBA TLP797GA consists of an infrared emitting diode optically coupled to a photo-MOS FET in a six lead plastic DIP package (DIP6).

The TLP797GA is a bi-directional switch which can replace mechanical relays in many applications.

- 6 pin DIP (DIP6)
- 1-form-A
- Peak off-state voltage: 400 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance:  $35 \Omega$  (max)
- Isolation voltage: 5000 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved : EN 60747-5-5 (Note 1)

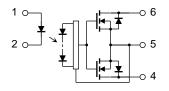
Note 1 : When a VDE approved type is needed, please designate the **Option(D4)**.

#### **Pin Configuration (top view)**

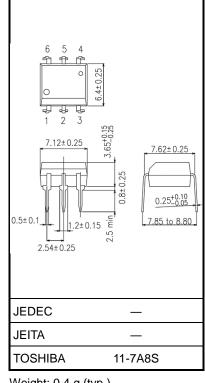


#### **Internal Circuit**

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Weight: 0.4 g (typ.)

#### Absolute Maximum Ratings (Ta = 25°C)

	Charact	Symbol	Rating	Unit	
	Forward current	lF	50	mA	
	Forward current de	erating (Ta $\ge$ 25°C)	∆l <sub>F</sub> /°C	-0.5	mA/°C
	Peak forward curre	ent(100 μs pulse, 100 pps)	IFP	1	А
LED	Reverse voltage		V <sub>R</sub>	5	V
	Diode power dissip	pation	P <sub>D</sub>	50	mW
	Diode power dissip	pation derating (Ta $\ge$ 25°C)	∆P <sub>D</sub> /°C	-0.5	mW/°C
	Junction temperate	ure	Tj	125	°C
	Off-state output te	rminal voltage	VOFF	400	V
		A connection		120	
	On-state current	B connection	Ion	120	mA
		C connection		240	
	On-state current derating (Ta ≥ 25°C)	A connection		-1.2	
		B connection	∆lon/°C	-1.2	mA/°C
Detector		C connection		-2.4	
Detector	Output power dissipation	A connection		453	
		B connection	Po	345	mW
		C connection		504	
	Output power	A connection		-4.53	
	dissipation derating	B connection	ΔPo /°C	-3.45	mW /°C
	(Ta ≥ 25°C)	C connection		-5.04	
	Junction temperate	Tj	125	°C	
Storage temperature range			T <sub>stg</sub>	-55 to 125	°C
Operating temperature range			T <sub>opr</sub>	-40 to 85	°C
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C
Isolation v	oltage (AC, 60 s, R.I	H. ≤ 60 %) (Note)	BVs	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Device considered a two-terminal device: Pins1, 2 and 3 shorted together, and pins 4, 5 and 6 shorted together.

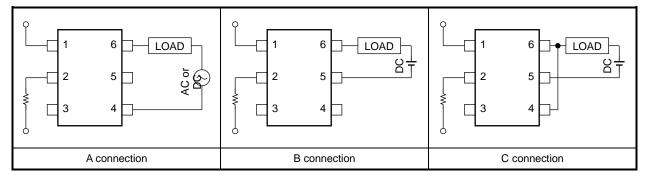
#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	Vdd	_	_	320	V
Forward current	lF	5	7.5	25	mA
On-state current	ION	—	_	120	mA
Operating temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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#### **Circuit Connections**



#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	IR	$V_R = 5 V$	_	_	10	μA
	Capacitance	Ст	V = 0 V, $f = 1 MHz$	_	30	_	pF
Detector	Off-state current	IOFF	$V_{OFF} = 400 V$	_	_	1	μA
	Capacitance	Coff	V = 0 V, $f = 1 MHz$		70		pF

#### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FT</sub>	$I_{ON} = 120 \text{ mA}$	_	1	3	mA
Load current limiting		IFC	IOFF = 100 μA	0.1	_	_	mA
	A connection		$I_{ON} = 120 \text{ mA}, I_F = 5 \text{ mA}$		17	35	Ω
On-state resistance	A connection	Davi	$I_{ON} = 20$ to 120 mA, $I_F = 5$ mA		20	40	
On-state resistance	B connection	R <sub>ON</sub>	$I_{ON} = 120 \text{ mA}, I_F = 5 \text{ mA}$	_	11	20	52
	C connection		$I_{ON} = 240 \text{ mA}, I_F = 5 \text{ mA}$	_	6	_	

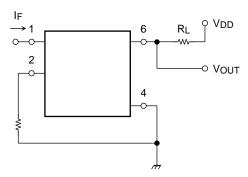
#### Isolation Characteristics (Ta = 25°C)

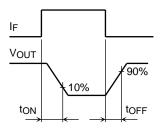
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	$V_S = 0 V$ , f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	$V_S=500$ V, R.H. $\leq 60$ %	$5\times 10^{10}$	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS	AC, 60 s	5000		_	Vrms

#### Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton		ote)	Ι	0.3	1	ms
Turn-off time	tOFF		ote)	Ι	0.1	1	ms

Note: Switching time test circuit





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